

0.5W High Power Laser Diode

Description

The SLD322XT is a high power, gain-guided laser diode produced by MOCVD method*1. Compared to the SLD300 Series, this laser diode has a high brightness output with a doubled optical density which can be achieved by QW-SCH structure*2.

Fine adjustment of the oscillation wavelength is possible by controlling the temperature using the built-in TE cooler (Peltier element).

*1 MOCVD: Metal Organic Chemical Vapor Deposition

*2 QW-SCH: Quantum Well Separate Confinement Heterostructure

Features

- High power
Recommended optical power output: Po = 0.5W
- Low operating current: Iop = 0.75A (Po = 0.5W)
- Flat package with built-in photodiode, TE cooler, and thermistor

Applications

- Solid state laser excitation
- Medical use
- Material processes
- Measurement

Structure

AlGaAs quantum well structure laser diode

Operating Lifetime

MTTF 10,000H (effective value) at Po = 0.5W, Tth = 25°C

Absolute Maximum Ratings (Tth = 25°C)

• Optical power output	Po	0.55	W
• Reverse voltage	VR	LD 2	V
		PD 15	V
• Operating temperature (Tth)	Topr	−10 to +30	°C
• Storage temperature	Tstg	−40 to +85	°C

Warranty

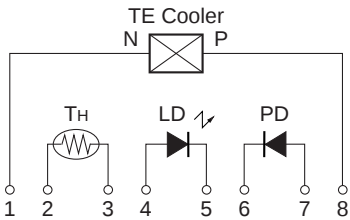
This warranty period shall be 90 days after receipt of the product or 1,000 hours operation time whichever is shorter.

Sony Quality Assurance Department shall analyze any product that fails during said warranty period, and if the analysis results show that the product failed due to material or manufacturing defects on the part of Sony, the product shall be replaced free of charge.

Laser diodes naturally have differing lifetimes which follow a Weibull distribution.

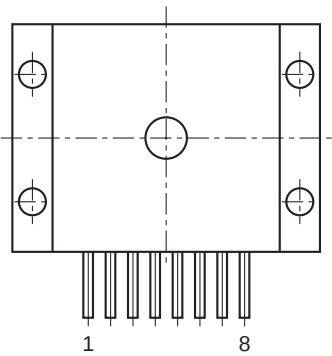
Special warranties are also available.

Equivalent Circuit



Pin Configuration (Top View)

No.	Function
1	TE cooler (negative)
2	Thermistor lead 1
3	Thermistor lead 2
4	Laser diode (anode)
5	Laser diode (cathode)
6	Photodiode (cathode)
7	Photodiode (anode)
8	TE cooler (positive)



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Electrical and Optical Characteristics

(Tth: Thermistor temperature, Tth = 25°C)

Item		Symbol	Conditions	Min.	Typ.	Max.	Unit
Threshold current		Ith			0.18	0.3	A
Operating current		Iop	P _O = 0.5W		0.75	1.2	A
Operating voltage		Vop	P _O = 0.5W		2.1	3.0	V
Wavelength*		λp	P _O = 0.5W	790		840	nm
Monitor current		I _{mon}	P _O = 0.5W V _R = 10V	0.15	0.8	3.0	mA
Radiation angle	Perpendicular	θ _⊥	P _O = 0.5W	20	30	40	degree
	Parallel	θ _{//}		4	9	17	degree
Positional accuracy	Position	ΔX, ΔY	P _O = 0.5W			±100	μm
	Angle	Δφ _⊥				±3	degree
Differential efficiency		η _D	P _O = 0.5W	0.5	0.9		W/A
Thermistor resistance		Rth	Tth = 25°C		10		kΩ

* Wavelength Selection Classification

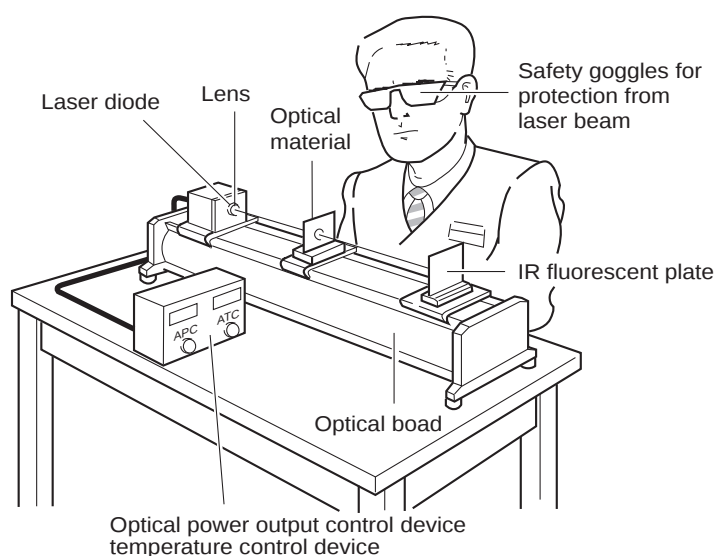
Type	Wavelength (nm)
SLD322XT-1	795 ± 5
SLD322XT-2	810 ± 10
SLD322XT-3	830 ± 10

Type	Wavelength (nm)
SLD322XT-21	798 ± 3
SLD322XT-24	807 ± 3
SLD322XT-25	810 ± 3

Handling Precautions

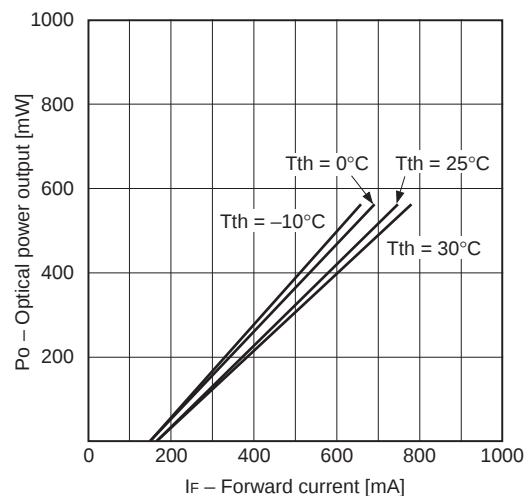
Eye protection against laser beams

The optical output of laser diodes ranges from several mW to 3W. However the optical power density of the laser beam at the diode chip reaches 1MW/cm². Unlike gas lasers, since laser diode beams are divergent, uncollimated laser diode beams are fairly safe at a laser diode. For observing laser beams, ALWAYS use safety goggles that block infrared rays. Usage of IR scopes, IR cameras and fluorescent plates is also recommended for monitoring laser beams safely.

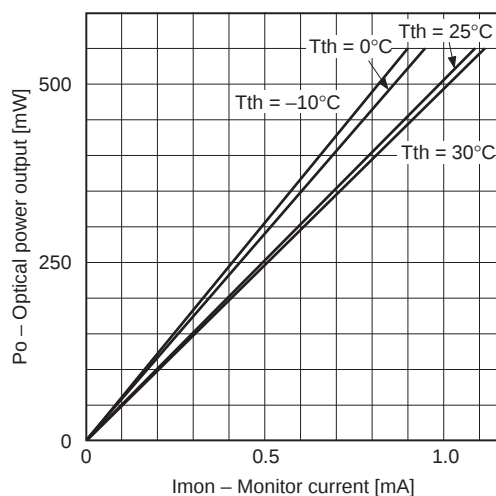


Example of Representative Characteristics

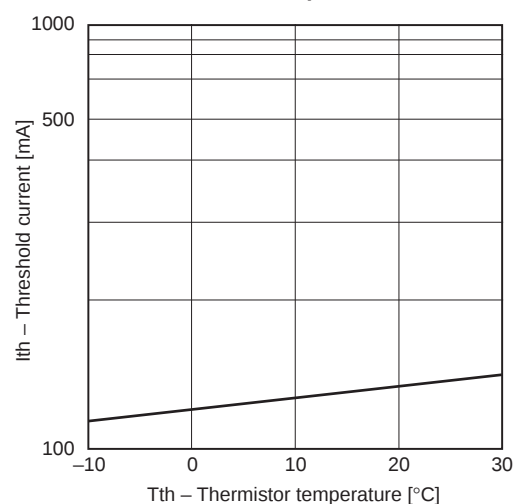
Optical power output vs. Forward current characteristics



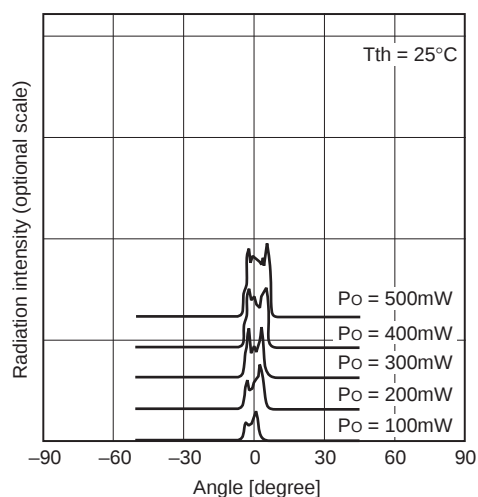
Optical power output vs. Monitor current characteristics



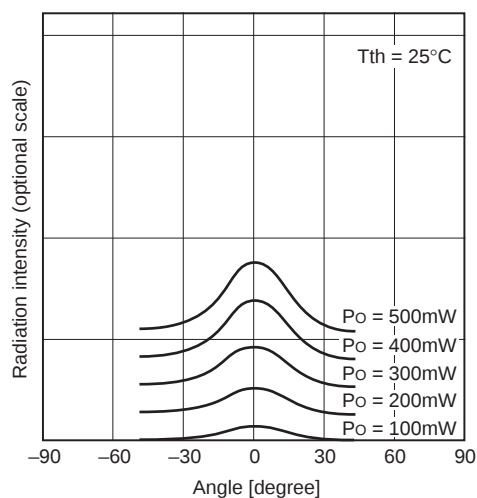
Threshold current vs. Temperature characteristics



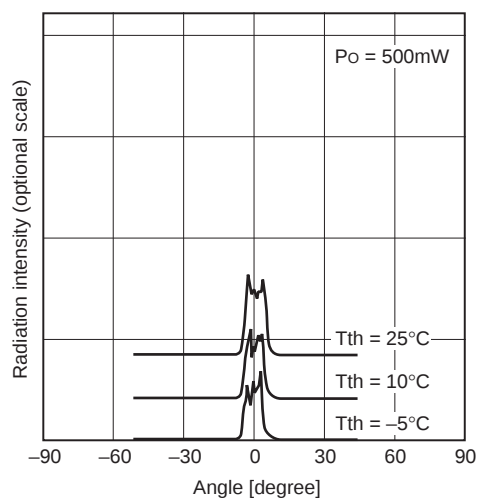
Power dependence of far field pattern (Parallel to junction)



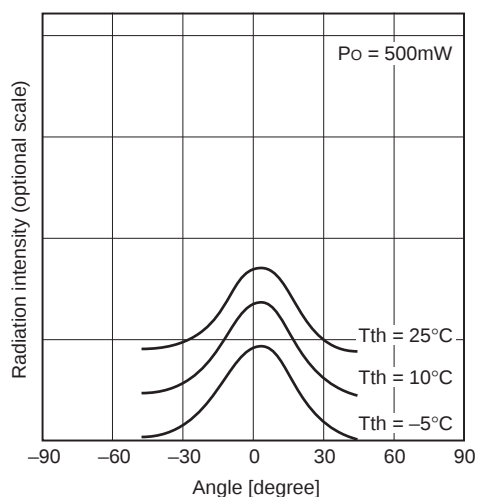
Power dependence of far field pattern (Perpendicular to junction)



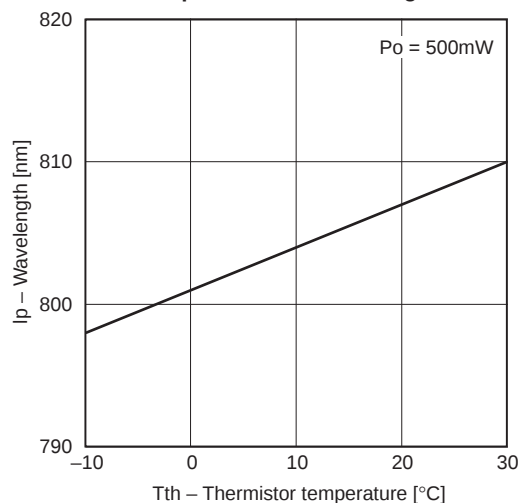
Temperature dependence of far field pattern (Parallel to junction)



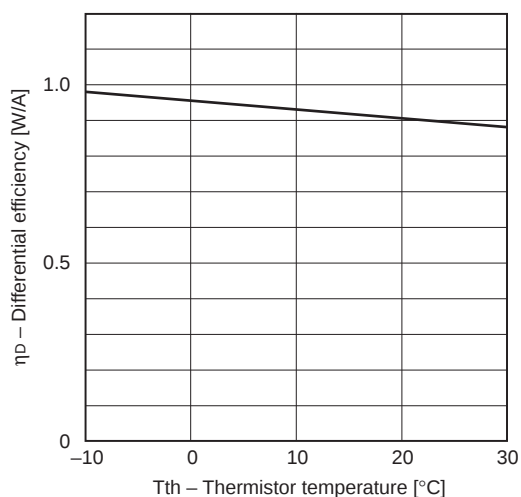
Temperature dependence of far field pattern
(Perpendicular to junction)



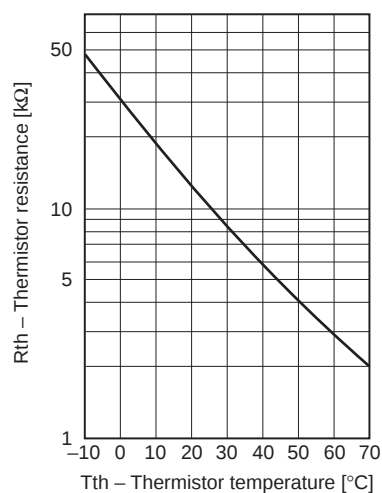
Dependence of wavelength



Differential efficiency vs. Temperature characteristics

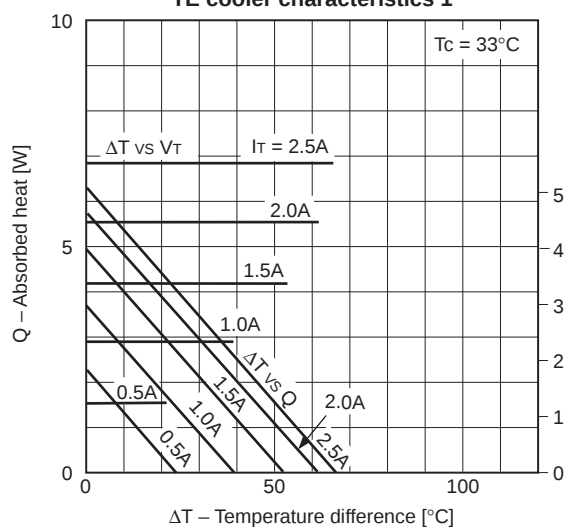


Thermistor characteristics



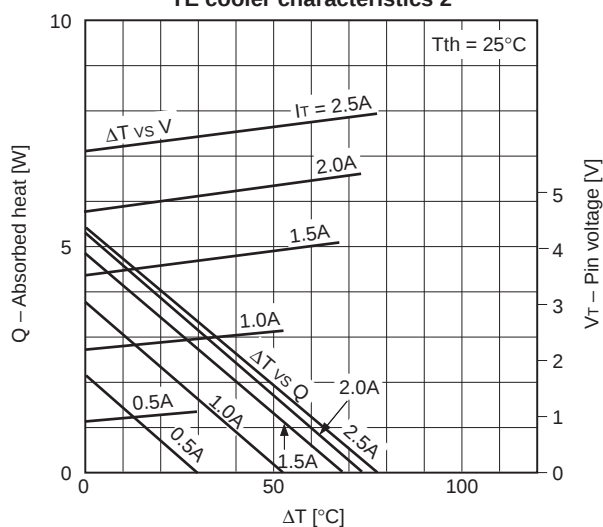
TE cooler characteristics

TE cooler characteristics 1

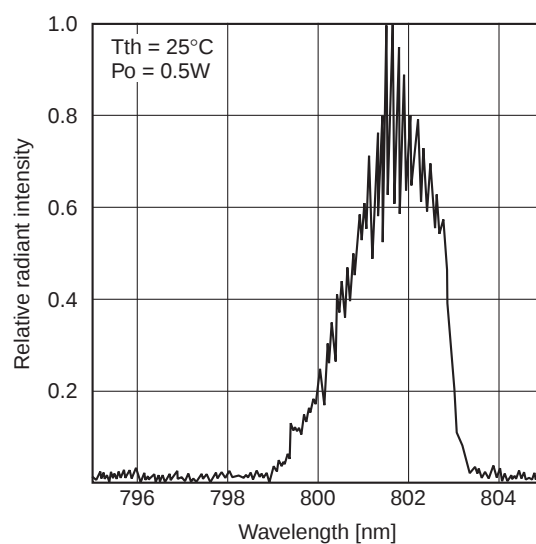
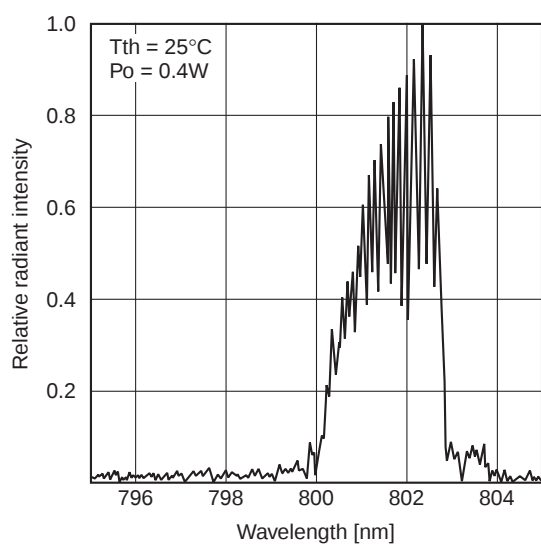
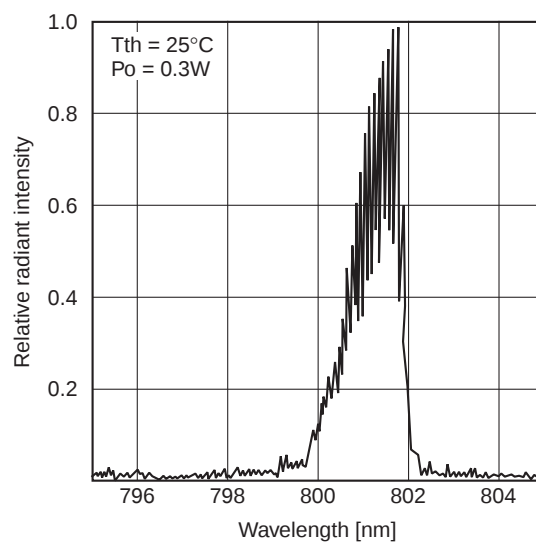
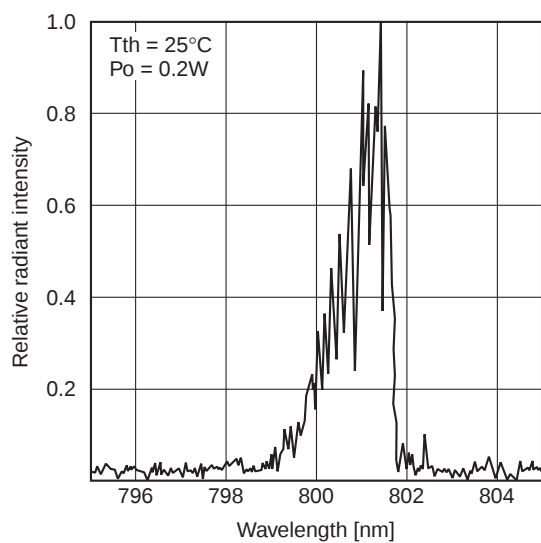


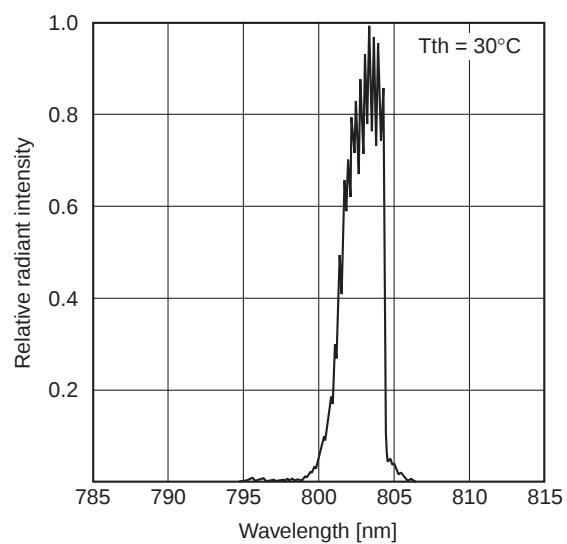
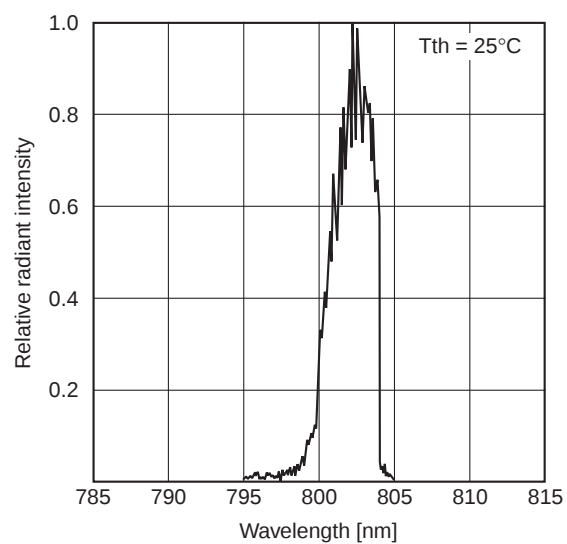
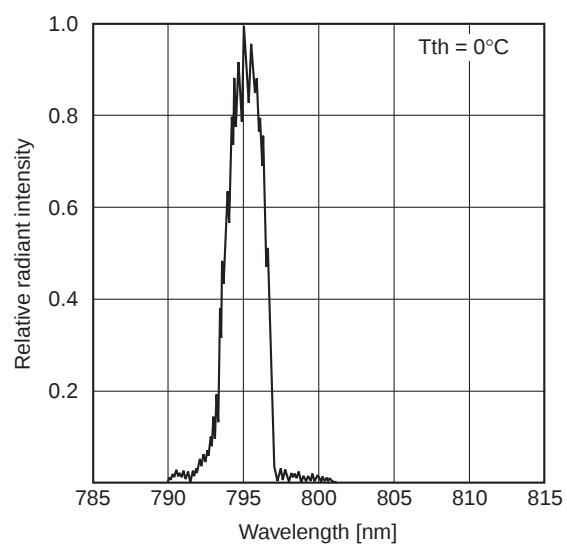
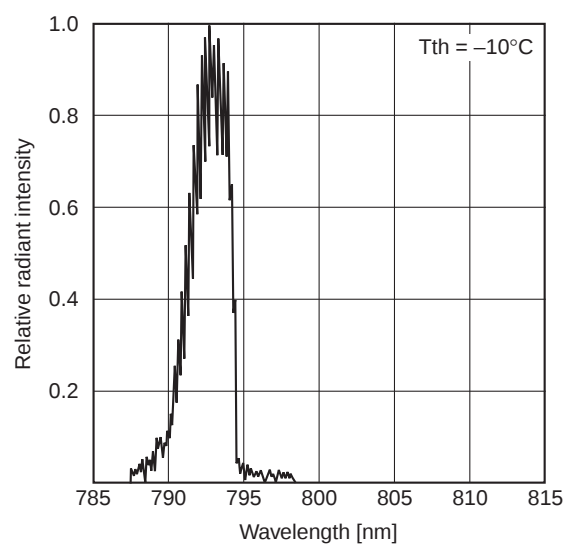
ΔT : $T_c - T_{th}$
 T_{th} : Thermistor temperature
 T_c : Case temperature

TE cooler characteristics 2



Power dependence of spectrum



Temperature dependence of spectrum ($P_o = 0.5W$)

Unit: mm

The technical drawing consists of two views: a top view and a side view.

Top View:

- Overall width: 33.0 ± 0.05
- Overall height: 28.0 ± 0.5
- Four mounting holes: $4 - \varnothing 3.0^{+0.05}_0$
- Central window: $\varnothing 5.0$, labeled "Window Glass"
- Pin pitch: 7.5 ± 0.1
- Pin length: $+2.0$ / -1.0
- Pin diameter: $8 - \varnothing 0.6$
- Pin width: 2.54
- Corner radius: $4 - R1.2 \pm 0.3$

Side View:

- Reference Plane to top surface: 10.4
- LD Chip thickness: 0.65MAX
- Carrier body width: 38.0 ± 0.5
- Carrier body height: 3.0
- Pin array width: 19.0
- Pin array pitch: 28.0 ± 0.5
- Pin array offset from center: $*16.5 \pm 0.1$
- Pin array depth: 7.5 ± 0.2
- Pin array total height: 11.35 ± 0.1

PACKAGE STRUCTURE

SONY CODE	M-273(LO-10)
EIAJ CODE	_____
JEDEC CODE	_____

PACKAGE WEIGHT	43g
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